CUSTOMER	•	
SAMPLE CODE (Ver.)	•	
MASS PRODUCTION CODE (Ver.)		PC2004LRS-AWA-B-Q (Ver.0)
DRAWING NO. (Ver.)	•	PC-95011

# **Customer Approved**

Date:

Approved	QC Confirmed	Designer
(2016-1-15 李紹妹		蔡木金1/4-06

- Approval For Specifications Only.
  - \* This specification is subject to change without notice.

Please contact Powertip or it's representative before designing your product based on this specification.

Approval For Specifications and Sample.

## POWERTIP TECH. CORP.

**Headquarters:** No.8, 6<sup>th</sup> Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: <a href="mailto:sales@powertip.com.tw">sales@powertip.com.tw</a>

Http://www.powertip.com.tw



# **RECORDS OF REVISION**

Date	Rev.	Description	Note	Page
2006/01/10	0	PC2004LRS-AWA-B-Qis the ROHS compliant part number based on Powertip's standard PC2004LRS-AWA-B		
_				

Total: 23 Page



### **Contents**

### 1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

### 2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Display Command
- 2.5 Character Pattern

## 3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

### 4. RELIABILITY TEST

4.1 Reliability Test Condition

### 5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Note: For detailed information please refer to IC data sheet: ST7066U,KS0063B



## 1. SPECIFICATIONS

### 1.1 Features

Item	Standard Value
Display Type	20*4 Character
LCD Type	STN Gray Positive Transflective Normal Temp.
Driver Condition	LCD Module: 1/32 Duty, 1/4 Bias
Viewing Direction	6 O'clock
Backlight	YG LED B/L
Weight	71 g
Interface	_
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

1.2 Mechanical Specifications

1/1001001100120012001200120120			
Item	Standard Value	Unit	
Outline Dimension	98.0(L) * 60.0(w) * 13.3(H)(Max)	mm	
Viewing Area	76.0(L) * 25.2(w)	mm	
Active Area	70.4(L) * 20.8(w)	mm	
Dot Size	0.55(L) * 0.55(w)	mm	
Dot Pitch	0.60(L) * 0.60(w)	mm	

Note: For detailed information please refer to LCM drawing

# 1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	$ m V_{DD}$	_	-0.3	7.0	V
LCD Driver Supply Voltage	$V_{LCD}$		VDD-10.0	V <sub>DD</sub> +0.3	V
Input Voltage	$V_{\rm IN}$		-0.3	V <sub>DD</sub> +0.3	V
Operating Temperature	$T_{OP}$	Excluded B/L	0	50	$^{\circ}$
Storage Temperature	$T_{ST}$	Excluded B/L	-20	70	$^{\circ}\mathbb{C}$
Storage Humidity	$H_D$	Ta<40 ℃	-	90	%RH



### 1.4 DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	$V_{DD}$	_	4.5	5.0	5.5	V
"H" Input Voltage	V <sub>IH</sub>	_	$0.7V_{DD}$	-	$V_{DD}$	V
"L" Input Voltage	V <sub>IL</sub>	_	-0.3	-	0.6	V
"H" Output Voltage	V <sub>OH</sub>	IOH=-0.1mA	3.9	-	$V_{DD}$	V
"L" Output Voltage	V <sub>OL</sub>	IOL=0.1mA	-	-	0.4	V
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> = 5.0 V	-	2.5	3.0	mA
		<b>0</b> °C	-	•	-	
LCM Driver Voltage	V <sub>OP</sub>	<b>25</b> ℃*1	4.2	4.4	4.6	V
		50℃	-	-	-	

Note: \*1. THE  $V_{OP}$  TEST POINT IS  $V_{DD}$  -  $V_{O}$ .

# 1.5 Optical Characteristics

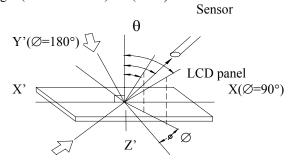
LCD Panel : 1/32 Duty , 1/5 Bias ,  $V_{LCD}\!=\!5.5~V$  ,  $Ta=25^{\circ}\!C$ 

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	C≥2.0, Ø = 0°	10°	-	-	Notes 1 & 2
Contrast Ratio	С	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	2	2.5	-	Note 3
Response Time(rise)	tr	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	100 ms	150ms	Note 4
Response Time(fall)	tf	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	160 ms	240ms	Note 4



### Note 1: Definition of angles $\theta$ and $\emptyset$

Light (when reflected)  $z (\theta=0^{\circ})$ 



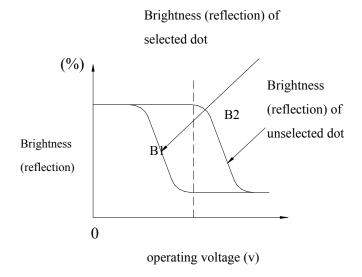
Light (when transmitted )  $Y(\varnothing=0^{\circ})$   $(\theta=90^{\circ})$ 

#### Note 3: Definition of contrast C

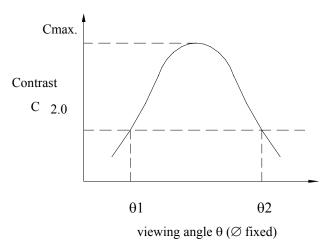
C = -

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)

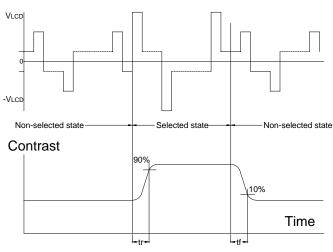


Note 2: Definition of viewing angles  $\theta 1$  and  $\theta 2$ 



Note: Optimum viewing angle with the naked eye and viewing angle  $\theta$  at Cmax. Above are not always the same

Note 4: Definition of response time



Note: Measured with a transmissive LCD panel which is displayed 1 cm<sup>2</sup>

$$\begin{split} V_{LCD} : Operating \ voltage & f_{FRM} : Frame \ frequency \\ t_r & : Response \ time \ (rise) & t_f : Response \ time \ (fall) \end{split}$$



# 1.6 Backlight Characteristics

## LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°C	-	650	mA
Reverse Voltage	VR	Ta =25°℃	-	8	V
Power Dissipation	PO	Ta =25°℃	-	3.0	W
Operating Temperature	$T_{OP}$	-	-20	70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-	-40	80	$^{\circ}\!\mathbb{C}$
Solder Temp. for 3 Second	-	-	-	260	$^{\circ}\!\mathbb{C}$

## Electrical / Optical Characteristics

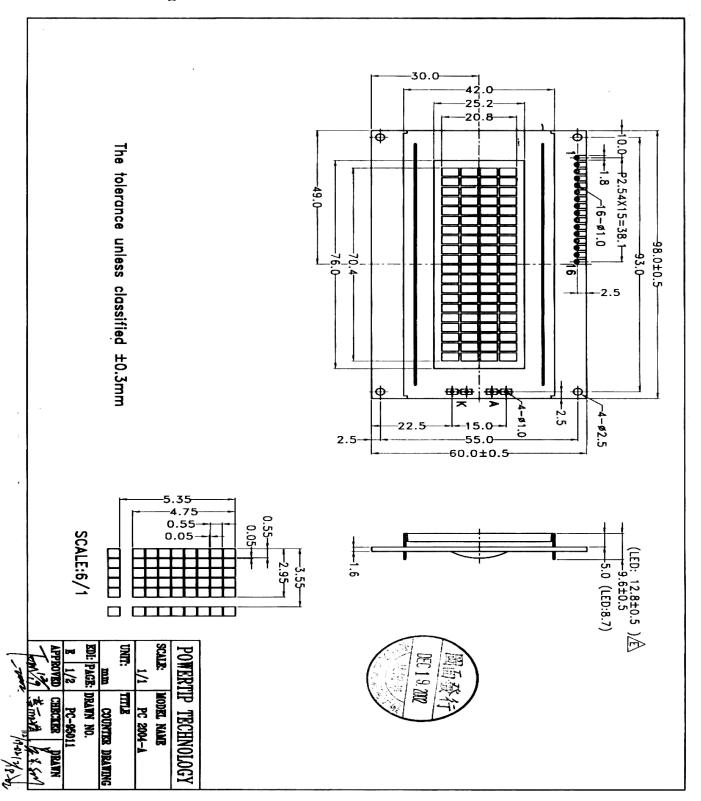
Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=260 mA	-	4.2	4.6	V
Reverse Current	IR	VR=8V	-	-	0.2	mA
Wavelength	Hue	IF=260 mA	569	-	575	nm
Luminous Intensity (without LCD)	IV	IF=260 mA	200	250		cd/m <sup>2</sup>
Color	Yellow-green					

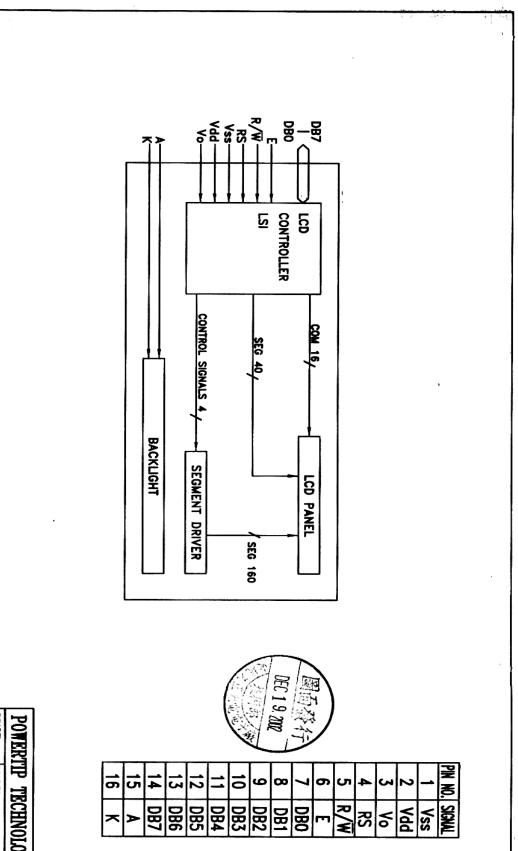


## 2. MODULE STRUCTURE

# 2.1 Counter Drawing





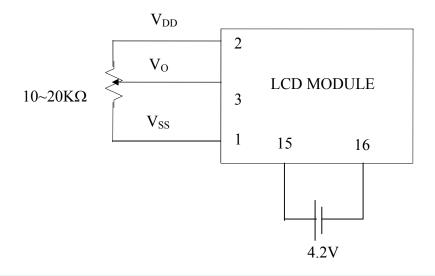




# 2.2 Interface Pin Description

Pin No.	Symbol	Signal Description			
1	Vss	Power Supply (V <sub>SS</sub> =0)			
2	Vdd	Power Supply (V <sub>DD</sub> >V <sub>SS</sub> )			
3	Vo	Operating voltage for LCD (variable)			
		Register Selection input			
4	RS	High = Data register			
4	KS	Low = Instruction register (for write)			
		Busy flag address counter (for read)			
		Read/Write signal input is used to select the read/write			
5	$R\overline{/W}$	mode.			
		High = Read mode, Low = Write mode			
6	E	Start enable signal to read or write the data			
		Four low order bi-directional three-state data bus lines.			
7~10	DB0 ~ DB3	Used for data transfer between the MPU and the LCD			
/~10	DB0 ~ DB3	module.			
		These four are not used during 4-bit operation.			
		Four high order bi-directional three-state data bus lines.			
11~14	$DB4 \sim DB7$	Used for data transfer between the MPU and the LCD			
		module.			
		DB7 can be used as a busy flag.			
15	A	Power supply for LED B / L (+ )			
16	K	Power supply for LED B / L (- )			

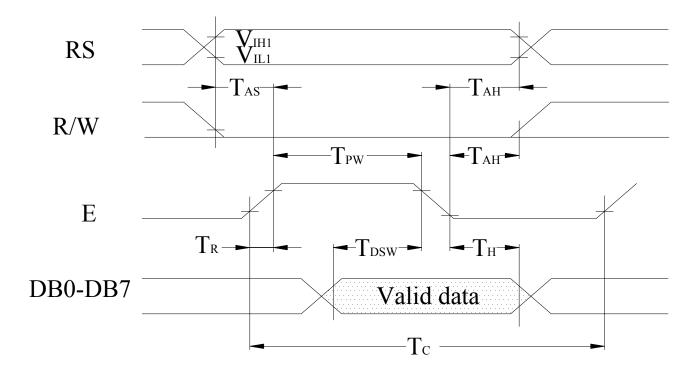
Contrast Adjust



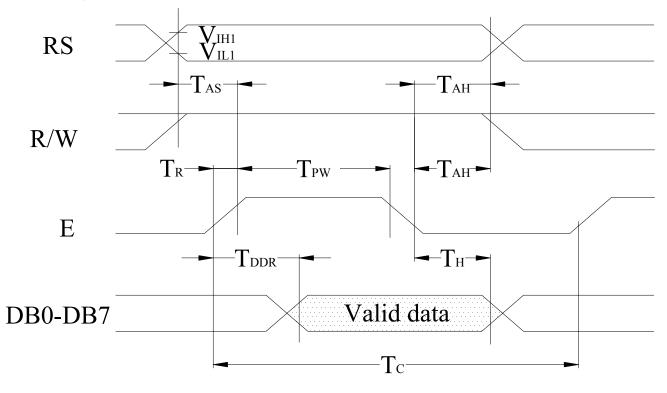


## 2.3 Timing Characteristics

• Writing data from MPU to ST7066U



• Reading data from ST7066U to MPU





## • Write Mode (Writing data from MPU to ST7066U)

 $(V_{cc} = +5V, Ta=25^{\circ}C)$ 

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{\rm C}$	Enable Cycle Time	Pin E	1200	ı	-	ns
$T_{PW}$	Enable Pulse Width	Pin E	140	-	-	ns
$T_R, T_F$	Enable Rise / Fall Time	Pin E	-	-	25	ns
$T_{AS}$	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
$T_{AH}$	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
$T_{DSW}$	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
$T_{\mathrm{H}}$	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

# • Read Mode (Reading data from ST7066U to MPU)

 $(V_{cc} = +5V, Ta=25^{\circ}C)$ 

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{C}$	Enable Cycle Time	Pin E	1200	ı	-	ns
$T_{PW}$	Enable Pulse Width	Pin E	140	-	-	ns
$T_R, T_F$	Enable Rise / Fall Time	Pin E	-	-	25	ns
T <sub>AS</sub>	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
$T_{AH}$	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
$T_{DDR}$	Data Setup Time	Pins:DB0~DB7	-	-	100	ns
$T_{\mathrm{H}}$	Data Hold Time	Pins:DB0~DB7	10	-	-	ns



# 2.4 Display Command

					Instru	ection	Code	;				Description
Instructions	RS	R/W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	×	Set DDRAM address to "00H" from AC and return cursor to it's original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37us
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1 : entire display on C=1 : cursor on B=1 : cursor position on	37µs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	×	×	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	37µs
Function Set	0	0	0	0	1	DL	N	F	×	×	DL: interface data is 8/4 bits NL: number of line is 2/1 F: font size is 5×11/5×8	37µs
Set CGRAM Address	0	0	0	1	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set CGRAM address in address counter.	37µs
Set DDRAM Address	0	0	1	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set DDRAM address in address counter.	37µs



Read Busy Flag and Address	0	1	BF	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0µs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	37µs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	37µs

### Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Refer to Instruction Table for the list of each instruction execution time .



## 2.5 Character Pattern

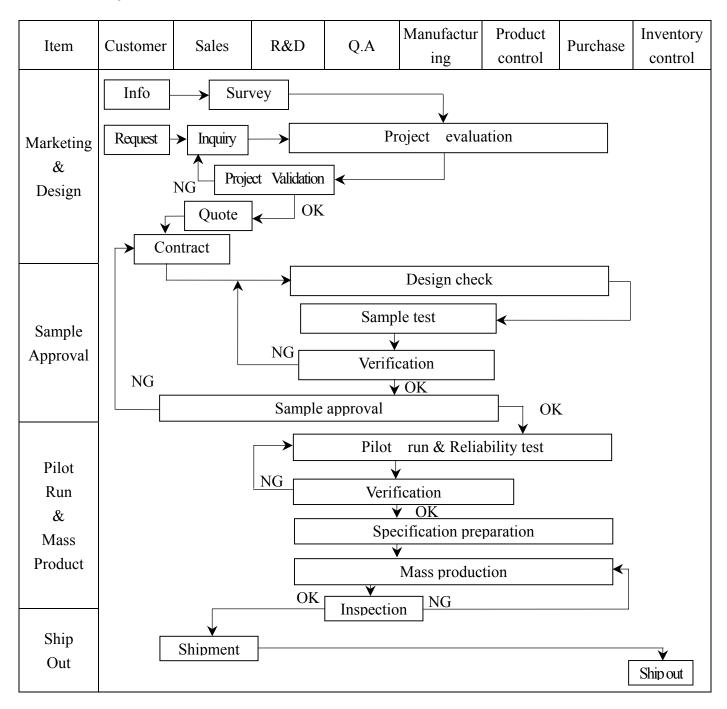
## ■ CHARACTER PATTERN(SO/HO/EA,WA)

Lorenza e Silvina a Silvina	0000	0001	0010	0011	0100	0101	0110	0111	1000 1001	1010	1011	1100	1101	1110	1111
хкжее	CB BAM (1)					ļ:	٠	ļ:::-				-::;	₩.		ļ:::
xxxx0001	(21)		i	1		I!	-:::	·::::		1:1	.]·*	::I:-	:;		::::
ююк0010	(3)		11	::::		I:::	<u> </u> ::::	į.···		Ī**	·   ·	٠.	.::: <sup>±</sup>	<b> </b> ::::	
***********	(4)		: : :		<u> </u>	::	:	::::-			ii	::::	₩	::::.	::-:
xxxx0100	(5)		::::	:::[.		<u>I</u>	:::	·!		٠	::I::	ŀ.	-[-::	ļl	
xxxx0101	(ñ)		:::::		<b></b>	ll	:::::	I		::	::¦	::		1	
ккжи0110	(7)			<u></u>	<b></b>	l.,.!	·¦	ı:		===					::::
жжж0111	(8)		:=			l,:,İ	::::	1,.,1		::::	:: ::	;:::'	•	: <u></u> [	H
0001xxxx	(1)		÷.	::::		;:::;		::::		į.	-:::	:-[::	i,.i	i'''	:-:
000x1001	(2)		Ī		<u>.</u>	٠	:	·!		::::	·"]"	!	l I.:	:	·
xxx1010	(3)		:- -:	::	I'					:::::	]				::[::
00001011	(4)			::	<b>!</b> ∷:	Ĭ	ŀ	•:		::·I·	<u>.</u>	<u></u>		:-:	
00001100	(5)		::	:	İ	ilii	i.	1		-]-::	!	i	·!	::::-	
xxx1101	(6)					!	   	:			: <u>:</u>	٠٠٠.	:	i	
xxxx1110	(7)		::	::·			l·"ı	:i-		I	1::	: [::	~~	:::	
000x1111	(0)	1		:	I			·i		: :.:	··	·-:'	:::	i	

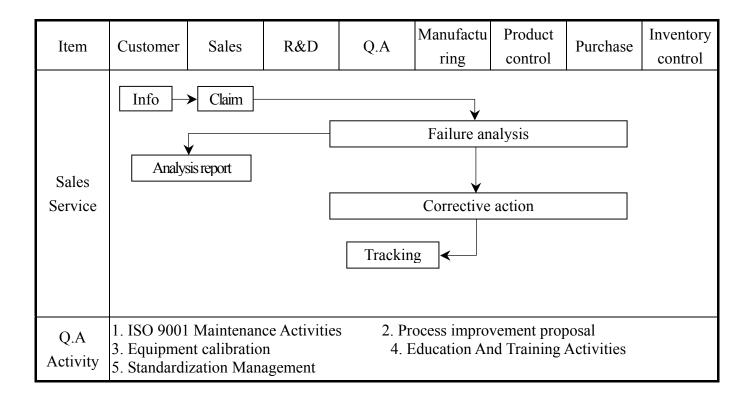


# 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart



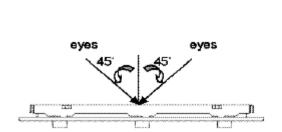


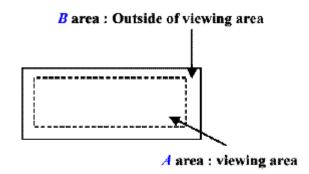




## 3.2 Inspection Specification

- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL 0.4; Minor Defect AQL 1.5.
- ◆OUT Going Defect Level : Sampling .
- ◆Manner of appearance test:
  - (1). The test be under 40W×2 fluorescent light 'and distance of view must be at 30 cm.
  - (2). The test direction is base on about around 45° of vertical line. (Fig. 1)
  - (3). Definition of area . (Fig. 2)





### ◆ Specification:

NO	Item	Criterion	level				
		1.1 The part number is inconsistent with work order of Production.	Major				
01	Product condition	.2 Mixed production types.					
		1.3 Assembled in inverse direction.	Major				
02	Quantity	2.1 The quantity is inconsistent with work order of production.					
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major				
		4.1 Missing line character \ dot and icon.					
		4.2 No function or no display.					
04	Electrical Testing	4.3 Output data is error.					
		4.4 LCD viewing angle defect.					
		4.5 Current consumption exceeds product specifications.	Major				
05	Black or white dot \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	<ul> <li>5.1 Round type:</li> <li>5.1.1 display only:</li> <li>• White and black spots on display ≤ 0.25mm, no more than Four white or black spots present.</li> <li>• Densely spaced: NO more than two spots or lines within 3mm</li> </ul>	Minor				



◆Specification:

NO	Item	Criterion						level	
05	Black or white dot · scratch · contamination Round type	0. 0.3	$\begin{array}{ c c c c c c }\hline & & w \leq 0.03 mm \\ L \leq 3.0 mm & 0.03 mm < \Phi \leq 0.05 m \end{array}$						
06	Polarizer Bubble	Φ ≤ 0.20mm < 0.50mm < Φ >	(diameter : $\Phi$ ) $\leq 0.20$ mm $< \Phi \leq 0.50$ mm $< \Phi \leq 1.00$ mm > $1.00$ mm	Acc	Acceptance area  ept no dense 3 2 0 4		Don't count Don't count Don't count Don't count Don't count Don't count	Minor	
07	The crack of glass	Fro Bac	Ek on the circuit of $X$ nt $X \le 1/5$	X	le terminal : $\frac{Y}{Y \le 1/2 D}$ Neglect		<u>Z</u> ≦ t	Minor	



◆Specification:

	ecification:				
NO	Item	Criterion			Level
		<ul><li>Glass Crack:</li><li>7.2 General glass crack a</li><li>7.2.1</li></ul>	×× ±.	Z.	
	The crack of glass	X	Y	Z	Minor
	X: The length of Crack	Neglect	Out A area	Neglect	
	Y: The width of crack	7.2,2	2		
07	Z: The thickness of crack		X		
	D: terminal length	X Neglect	Y Out A area	Z Neglect	
	T: The thickness of glass	Neglect	Out A area	regicei	
	A : The length of glass	7.3 Glass remain:			
				<del>Y</del> /3 d	Minor



◆Specification:

NO	Item	Criterion			Level		
07	The crack of glass  X: The length of Crack  Y: The width of crack  Z: The thickness of crack  D: terminal length  T: The thickness of	7.4 Corner cr.	ack and medial crack:	X SP G]	Minor		
	glass	X	Y	Z			
	A: The length of	≤1/5a	Crack can't enter viewing area	≤1/2t	_[]		
	glass	≤1/5a	Crack can't exceed the half of width of SP width of SP	$1/2t < Z \le 2t$			
		8.1 Backlight	can't work normally.		Major		
08	Backlight elements	8.2 Backlight doesn't light or color is wrong.					
	Cicinents	8.3 Illumination source flickers when lit.					
		9.1 pin type m	ust match type in specification she	et	Major		
		9.2 No short ci	rcuits in components on PCB or F	PC	Major		
09	General appearance	9.3Product packaging must the same as specified on packaging specification sheet.					
		9.4 The folding and peeled off in polarizer are not acceptable					
			or FPC between B/L assembled depth or SPC) is $\leq 1.5$ mm	istance	Major		



## 4. RELIABILITY TEST

# 4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in 70 ±2°C 96 hrs				
		Surrounding temperature, then storag	e at normal condition 4hrs			
2	Low Temperature Storage Test	Keep in -20 ±2°C 96 hrs				
		Surrounding temperature, then storag	e at normal condition 4hrs			
		Keep in +60°C/90%RH duration for 9	96 hrs			
3	High Humidity Storage	Surrounding temperature, then storage at normal condition 4hrs (Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs				
		1. Sine wave $10 \sim 55$ HZ frequency	(1 min)			
4	Vibration Test	2. The amplitude of vibration :1.5 n				
		3. Each direction (XYZ) duration for				
		Air Discharge:	Contact Discharge:			
		Apply 6 KV with 5 times Discharge foreach polarity +/-  1. Temperature ambinace:15°C ~35	Apply 250V with 5 times discharge foreach polarity +/-			
5	ESD Test	<ul> <li>2. Humidity relative:30%∼60%</li> <li>3. Energy Storage Capacitance(Cs+Cd):150pF±10%</li> </ul>				
		<ul> <li>4. Discharge Resistance(Rd):330 Ω±10%</li> <li>5. Discharge, mode of operation:</li> <li>Single Discharge (time between successive discharges at least 1 s)</li> </ul>				
		(Tolerance If the output voltage indication: ±5%)				
		$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C}$	$\mathbb{C} \to 25^{\circ}\mathbb{C}$			
6	Temperature Cycling Test	(30mins) (5mins) (3	Omins) (5mins)			
		Surrounding temperature, then storage at normal condition 4hrs				
		1. Sine wave $10 \sim 55$ HZ frequency (				
7	Vibration Test (Packaged)	2. The amplitude of vibration :1.5 m	m			
		3. Each direction (XYZ) duration for				
		` ` `	Drop Height (cm)			
		0 ~ 45.4	122			
		45.4 ~ 90.8	76			
8	Drop Test (Packaged)	90.8 ~ 454	61			
		Over 454	46			
		Drop direction: **3 comer	/1 edges /6 sides etch 1times			



### 5. PRECAUTION RELATING PRODUCT HANDLING

### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

### **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.